

Annex B.ii. Photograph 2: EUT Internal Photo



Cover Off - Top View



Cover Off - Rear Housing View



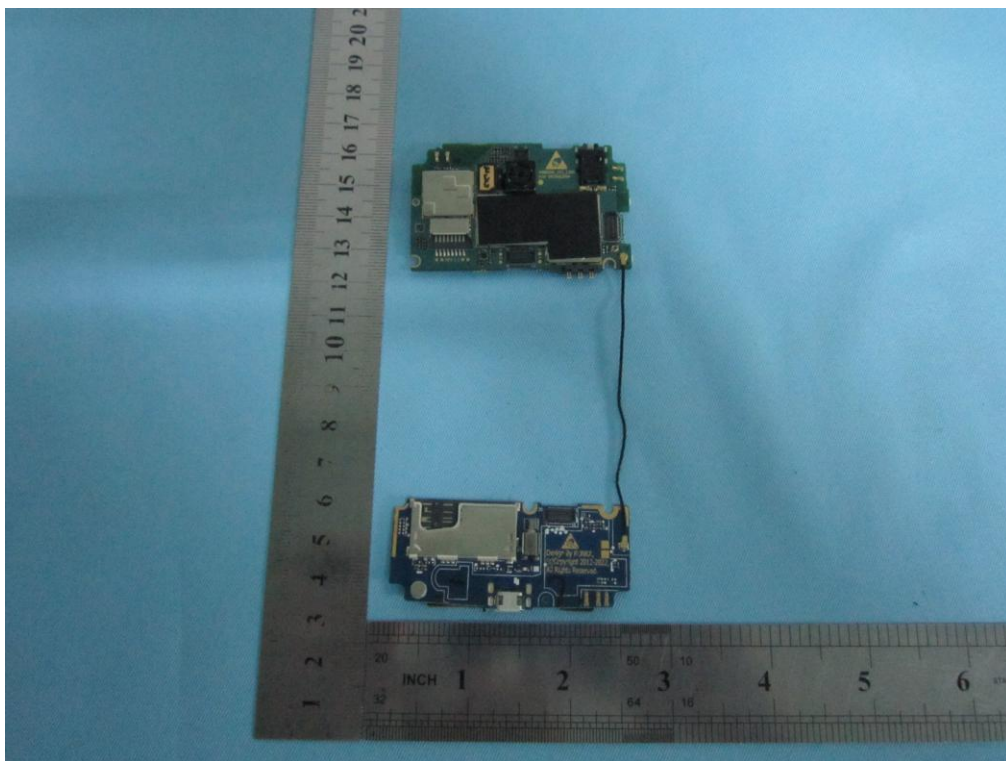
Adapter View



Battery View



Rear Housing - Uncover View



Mainboard - Bottom View

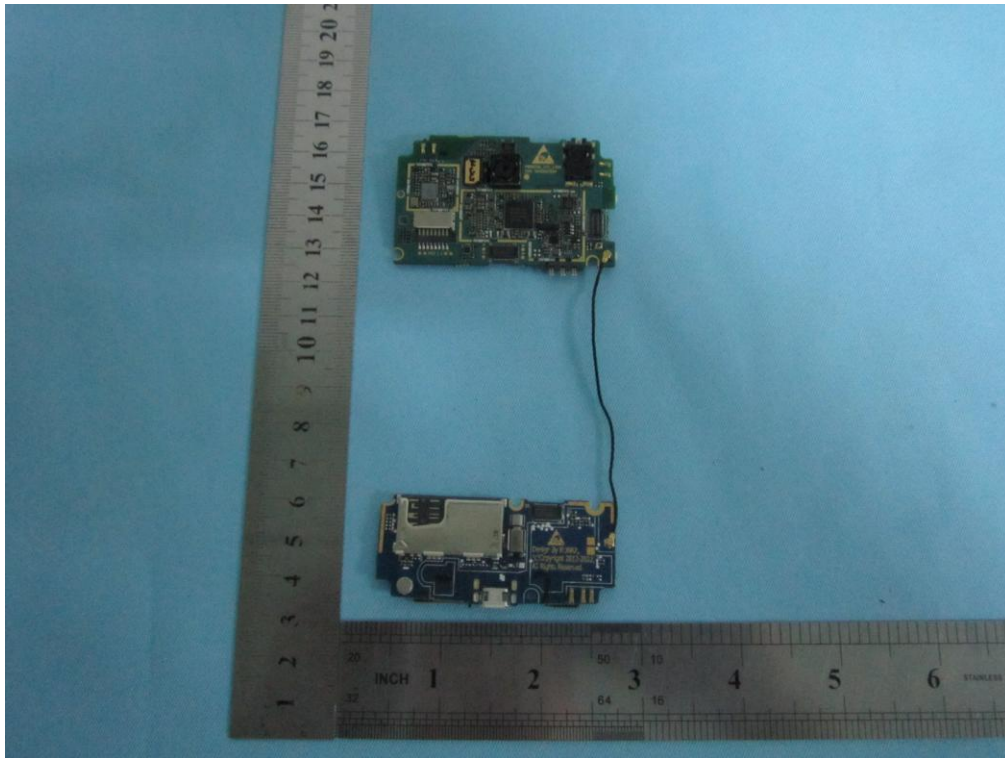


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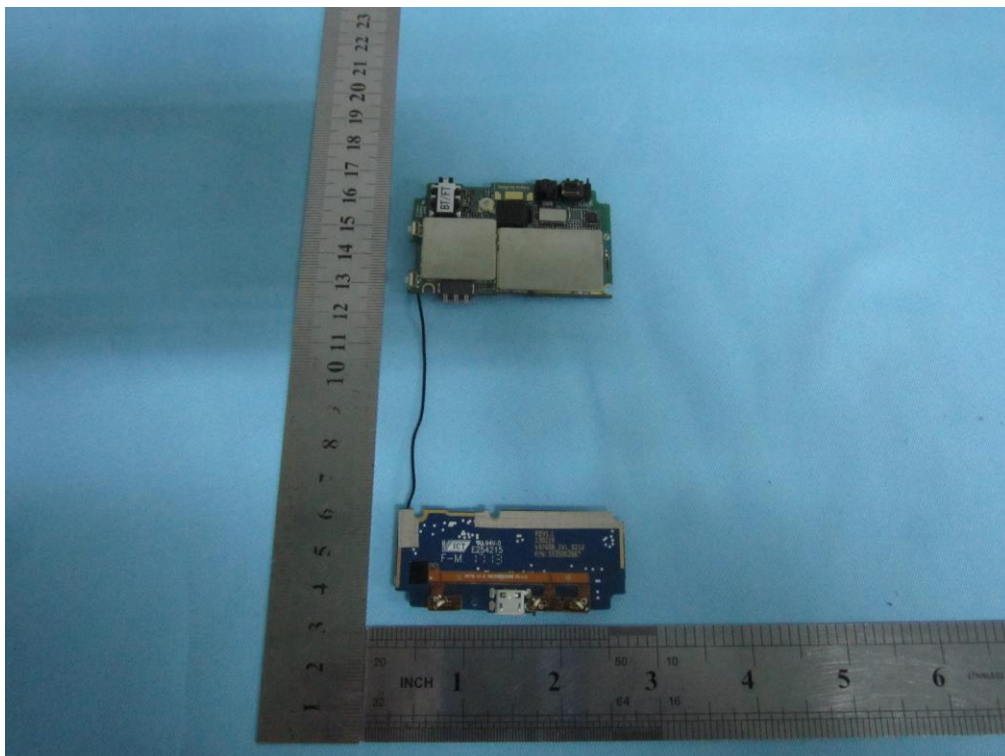
Accessing global markets

Title: EMC Test Report for Mobile Phone
Main Model: S470
Serial Model: N/A
To: FCC Part 15 Subpart B Class B: 2012 , ANSI C63.4:2009

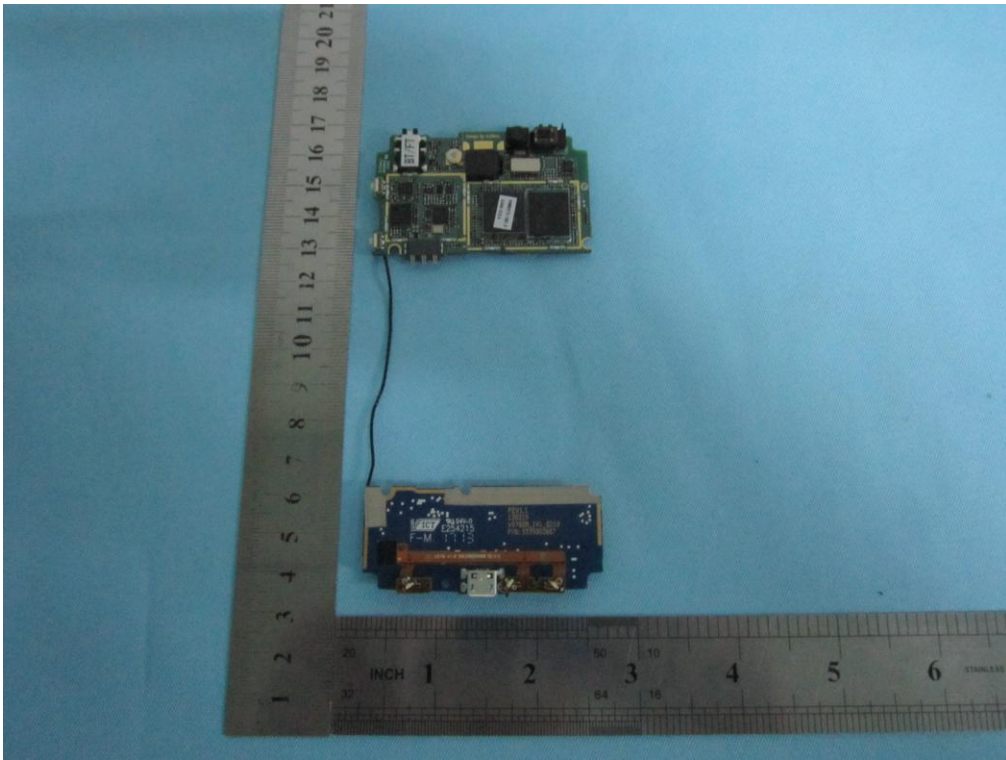
Report No.: 13070170-FCC-E
Issue Date: July 26, 2013
Page: 26 of 35
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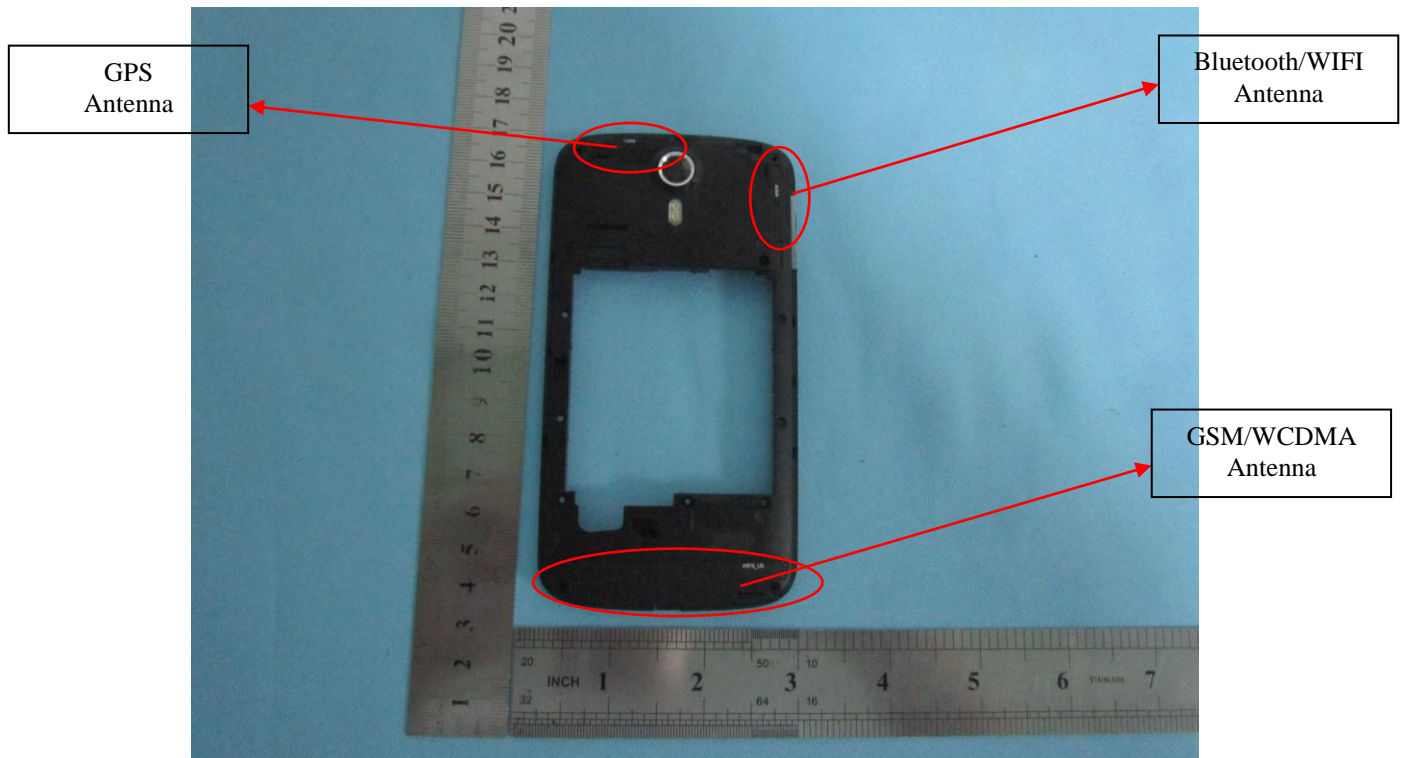
Mainboard Without Shielding - Bottom View



Mainboard - Top View



Mainboard Without Shielding - Top View



Antenna View